

THIN DIELECTRIC LAYERS ON CONDUCTORS AND METHODS OF MAKING THE
SAME

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Abstract

Apparatus comprising: a first substrate; a dielectric layer comprising a first dielectric material on the first substrate, the dielectric layer having a dielectric layer thickness and being traversed by through holes passing from an interface with the first substrate, to an opposite side of the dielectric layer; and a second dielectric material at least partially blocking the through holes. Methods for making such apparatus.

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